

High Speed Sensing and Monitoring around GaN devices

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iMAPS-UK Research Showcase: Recent Advances in
Reliability and Gate driving of Wide Bandgap Power Electronics
11-12 Jan 2021



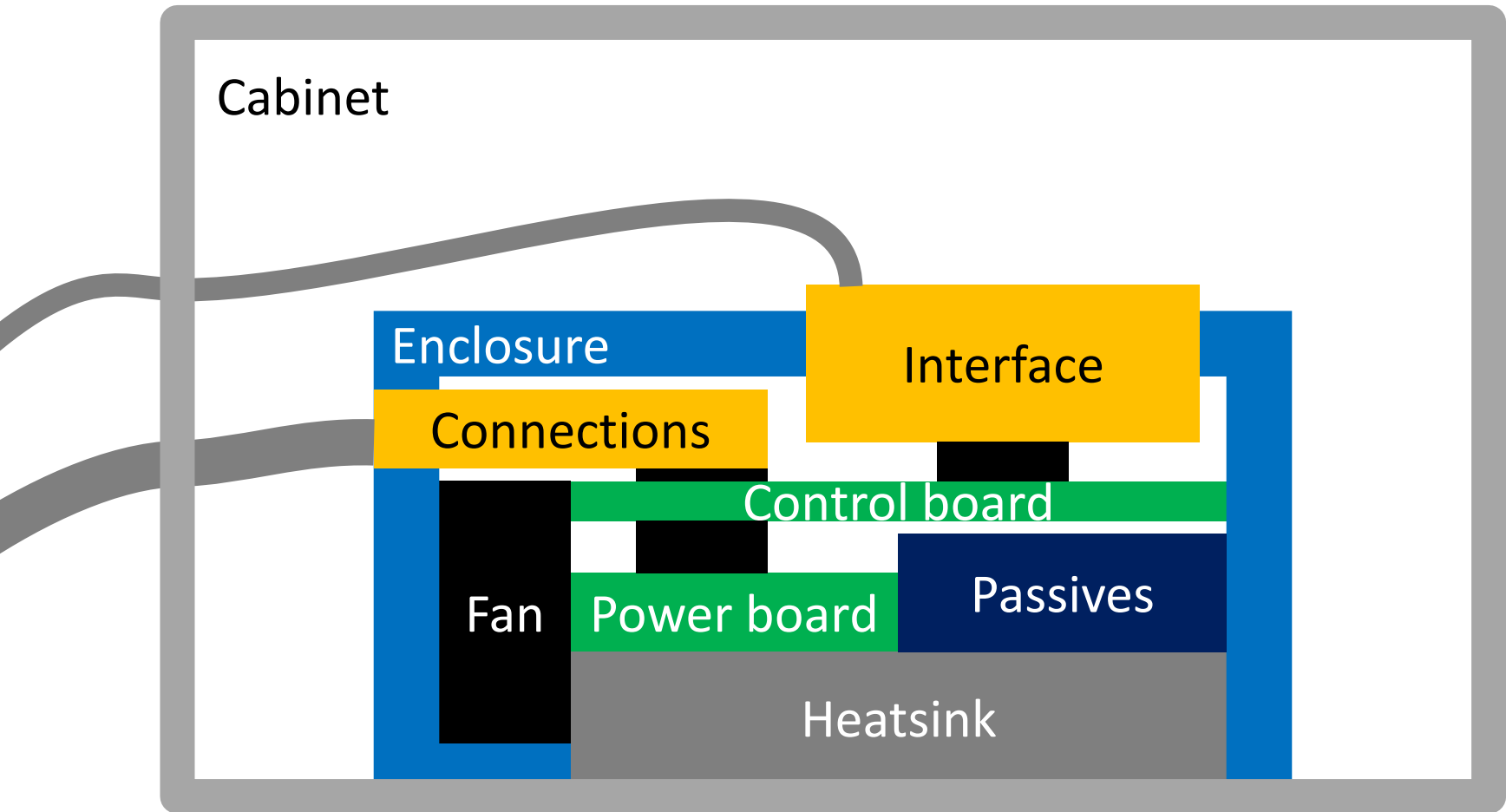
Engineering and
Physical Sciences
Research Council



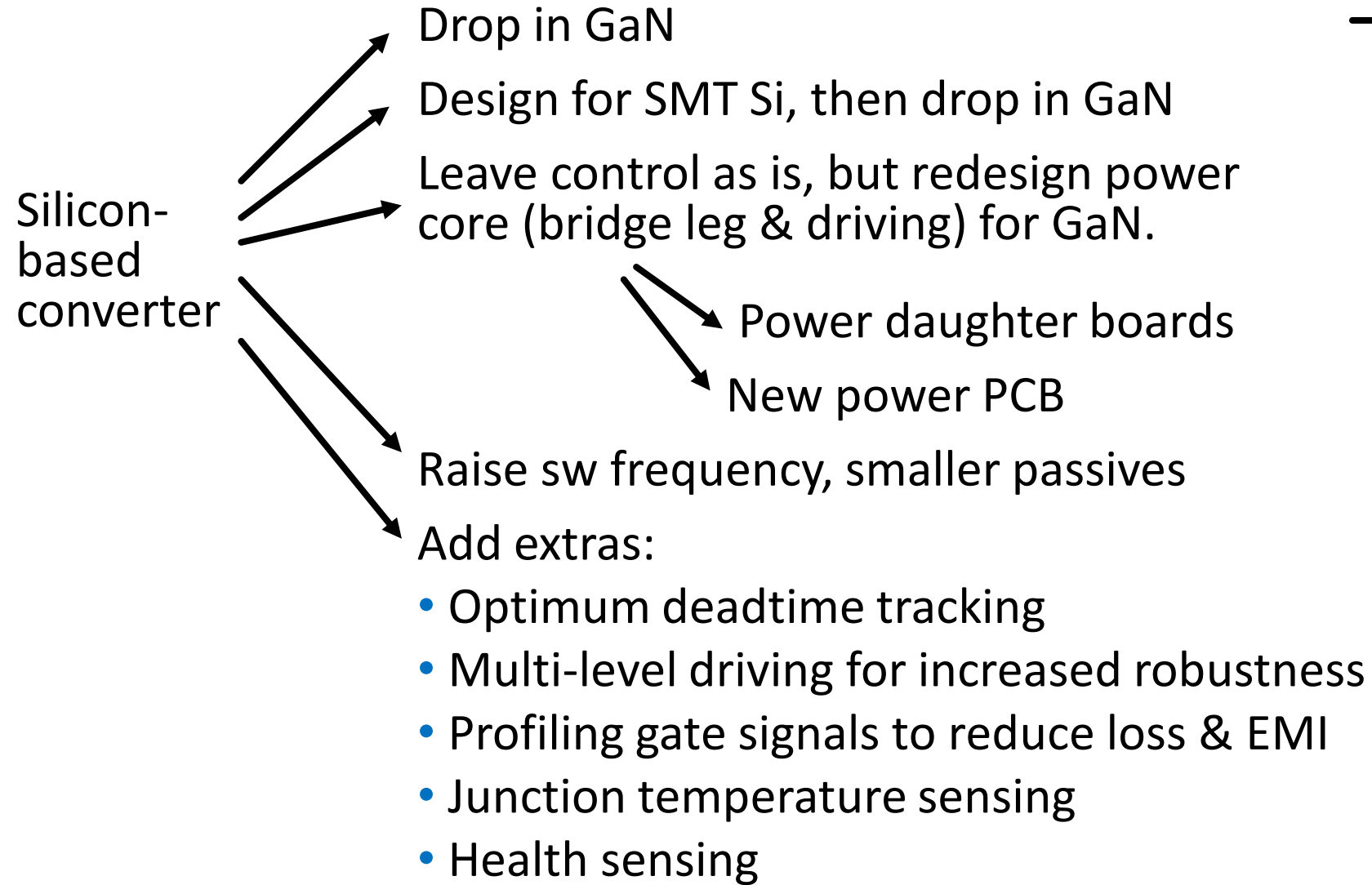
Outline

- How do you figure out if it's worth moving from Silicon to GaN?
- New product or modify existing one?
- How get the best from GaN in your power circuit
- Do you need new measurement equipment?
Maybe. Contact measurement gets harder.
- Does anything get easier?
Yes! Field-based measurement (e.g. current, voltage, temperature)
- Research into better gate drivers for GaN

How do you figure out if it's worth moving from Silicon to GaN?



New product or modify existing one?



⇒ Core needs adapting, incl. gate driving

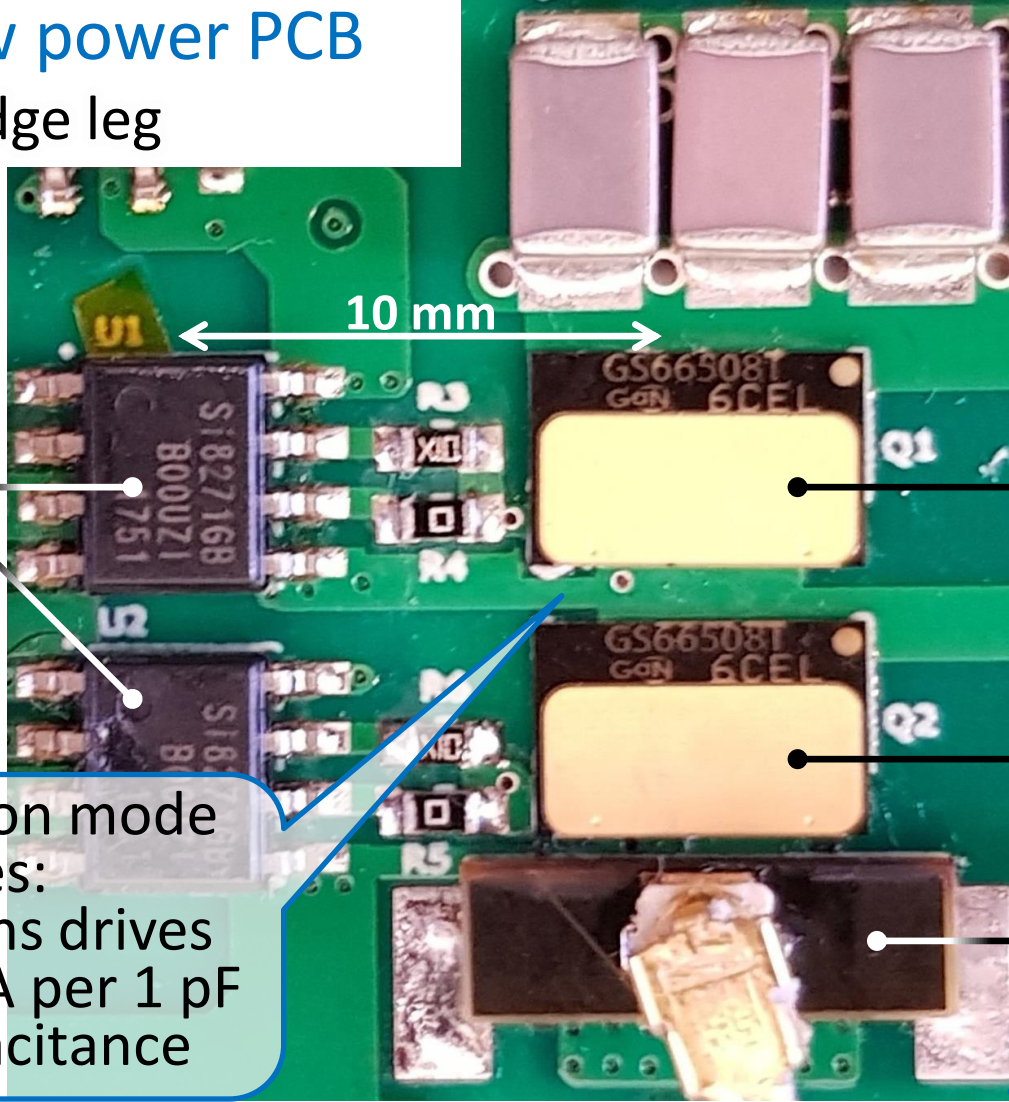
⇒ Probably also fundamental behaviour such as switching frequency

The new power PCB

2 kW bridge leg

100 V/ns

10 A/ns



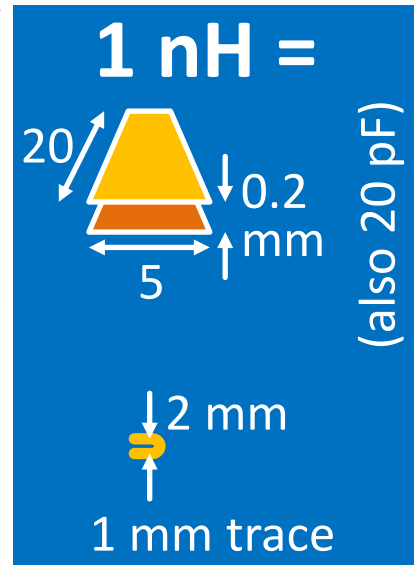
Common mode voltages:
100 V/ns drives
100 mA per 1 pF
of capacitance



Upper GaN FET

Lower GaN FET

Infinity Current Sensor

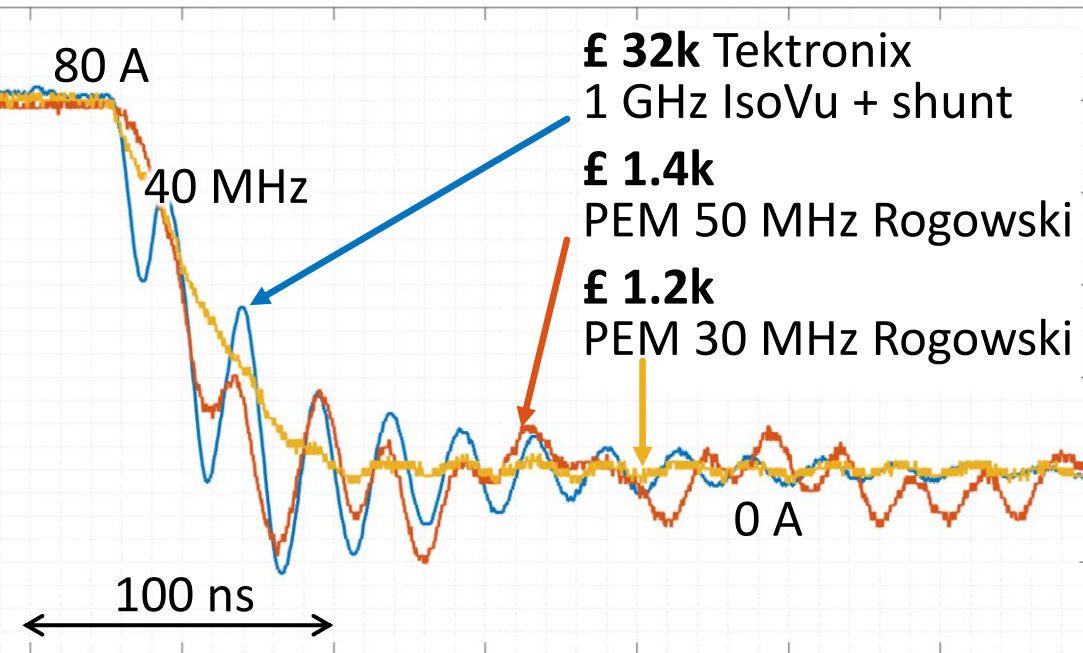


- Crucial: Layout, packages, pinouts, com. mode transient immunity CMTI.
- For same voltage overshoot, loop inductances need to reduce 10x.
- For same current overshoot, parasitic capacitances need to drop 10x.
- Resonances are now 100s of MHz.

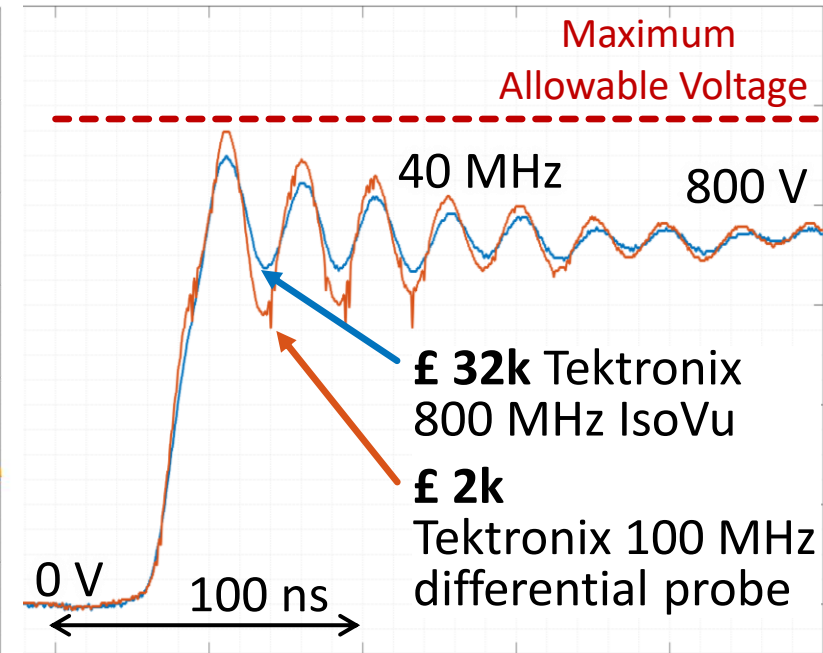
Do you need new measurement equipment?

Using slower **SiC** as an example:

Current measurement



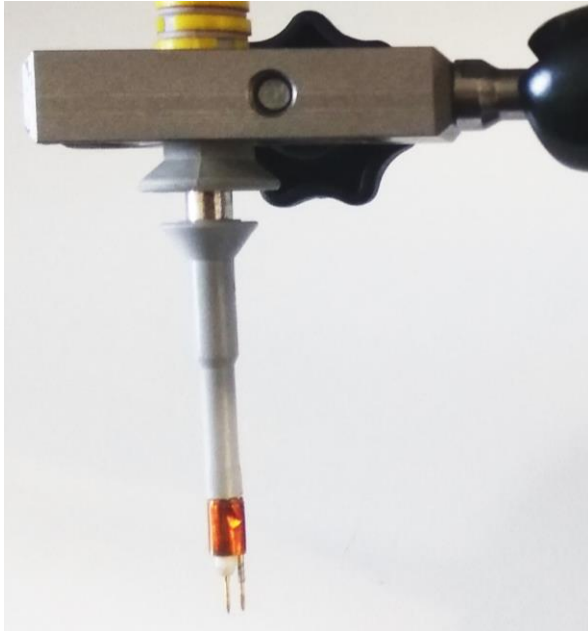
High-side voltage measurement



- With **GaN**, the slopes and ringing frequencies are **10× higher**
- 1 GHz single-ended probes for the low side, optically isolated measurement for the high side, due to common mode voltages
- Consider switching from contact sensing to field sensing.

Measurement of V and I

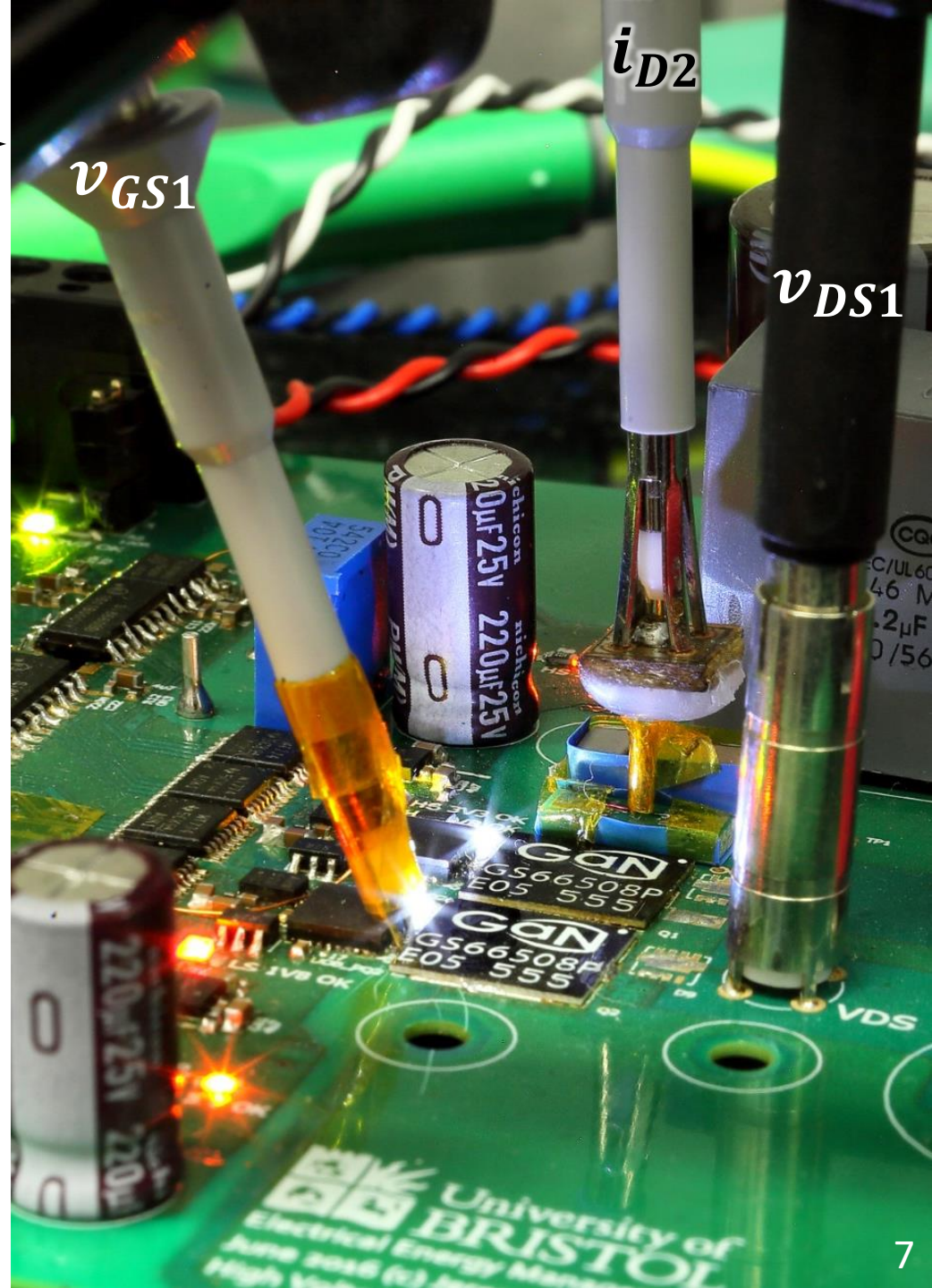
Some options shown here →
Cut down parasitic coupling



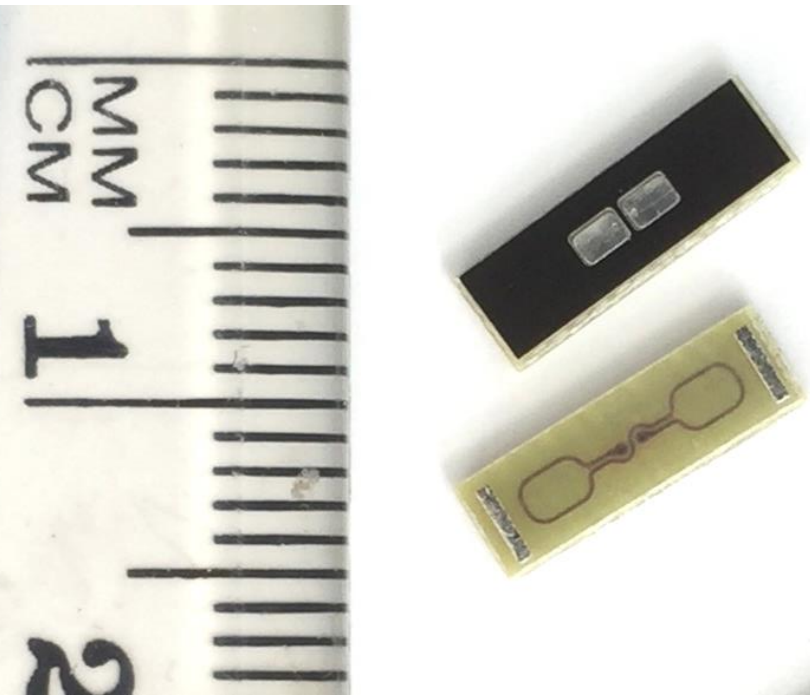
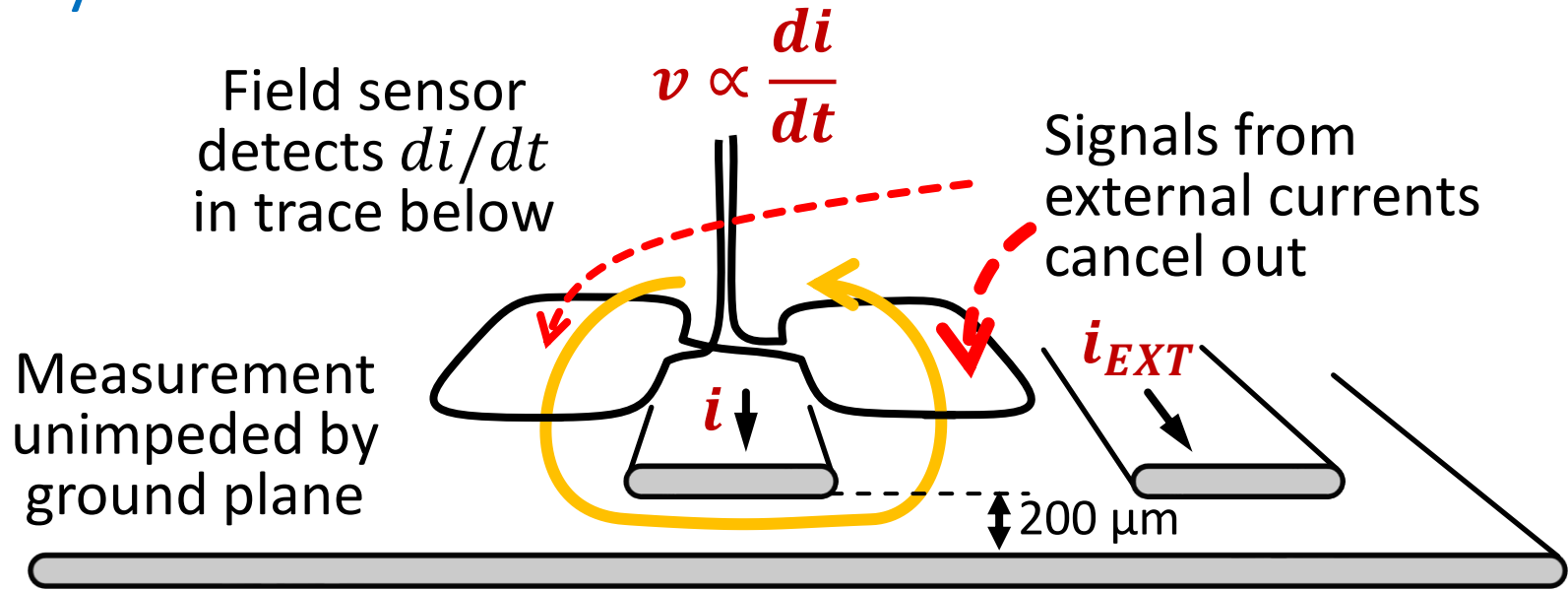
Don't stretch power loop to make space for current probes



Optical isolation:
120 dB rejection
of common mode



Infinity current sensor



10×3mm

Around 200 mV per A/ns

500+ MHz (work in progress)

0.2 nH insertion inductance

More info at

Infinity Sensor: Temperature Sensing in GaN Power Devices using Peak di/dt , 2018 IEEE Energy Conversion Congress and Exposition (ECCE)

For samples, contact bernard.stark@bristol.ac.uk

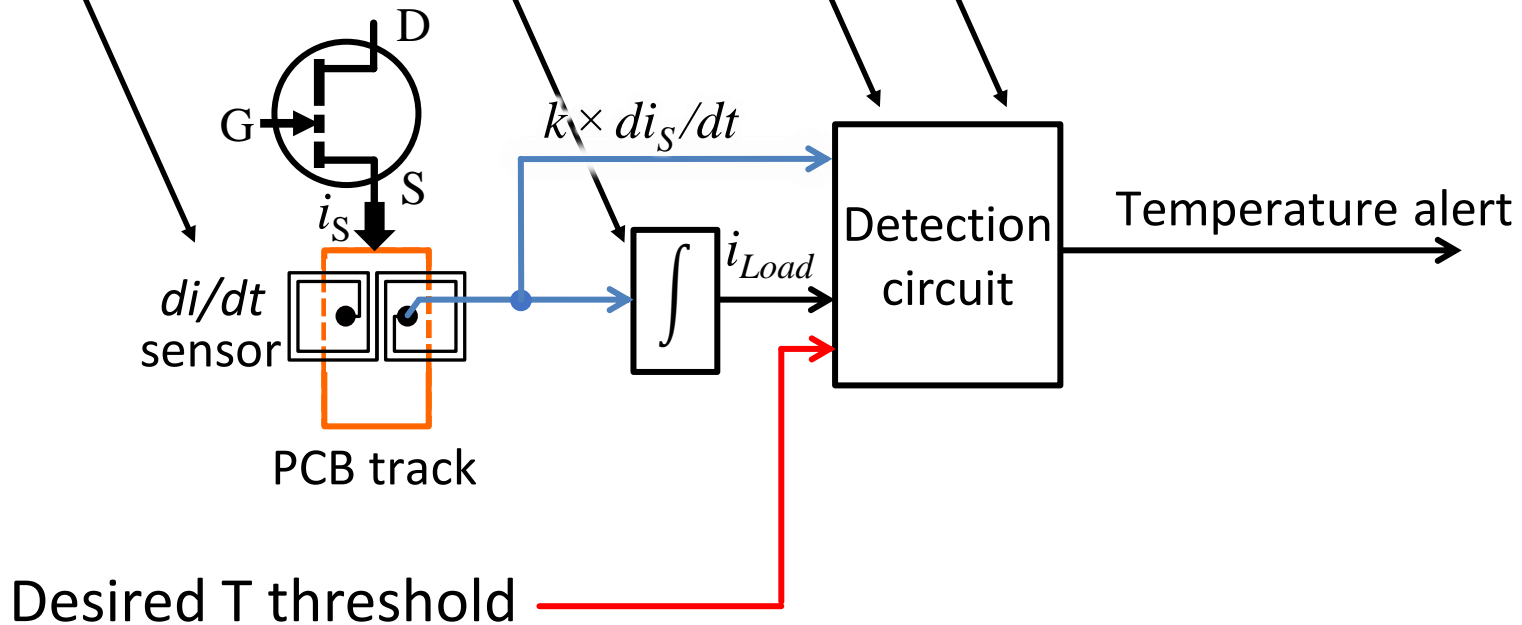
Junction temperature monitoring using di/dt sensor

1) Sense di/dt at turn-on

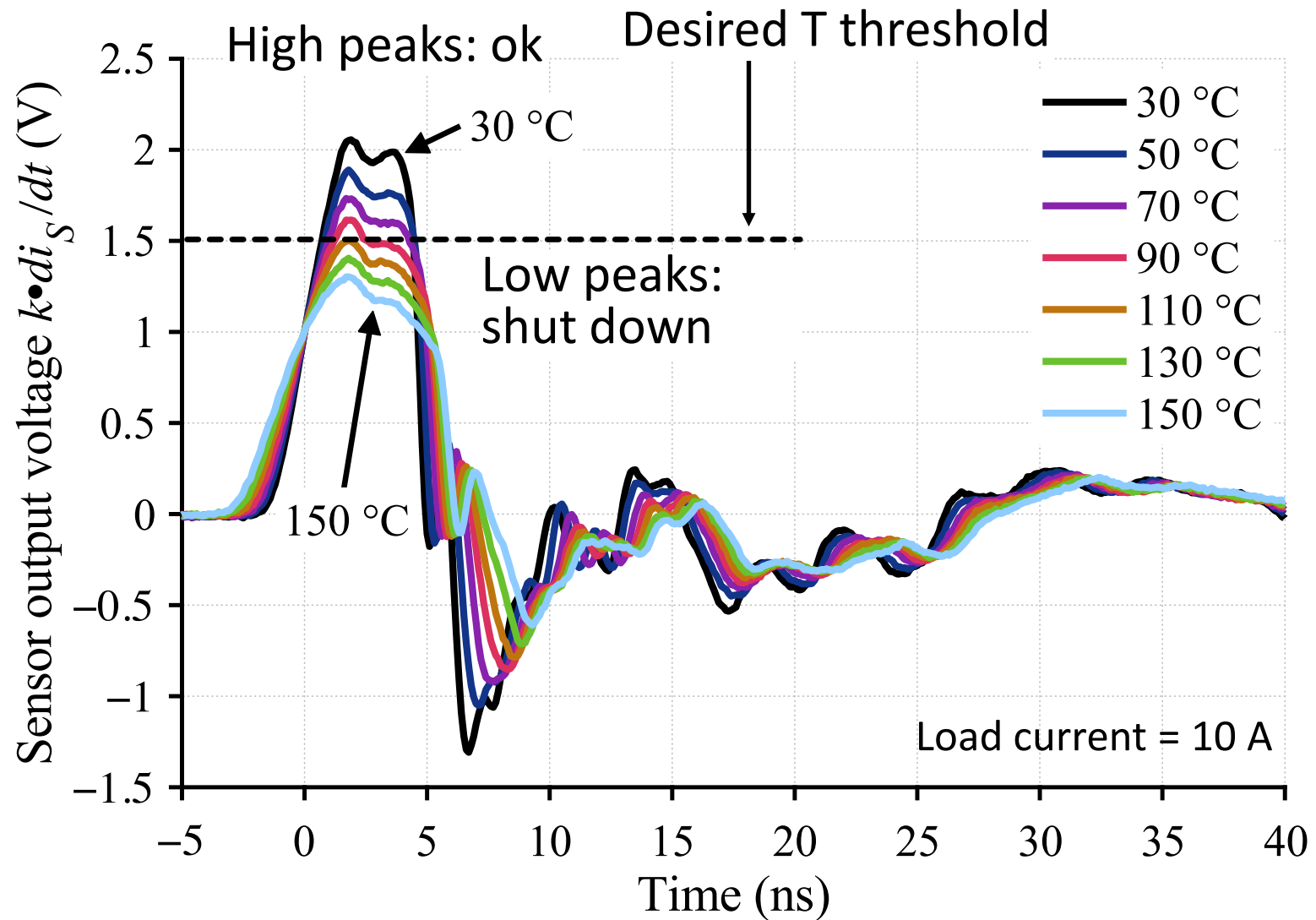
2) Temperature is derived from di/dt (higher T = lower di/dt)

3) Integrate di/dt to obtain load current

4) Use load current to correct T derivation



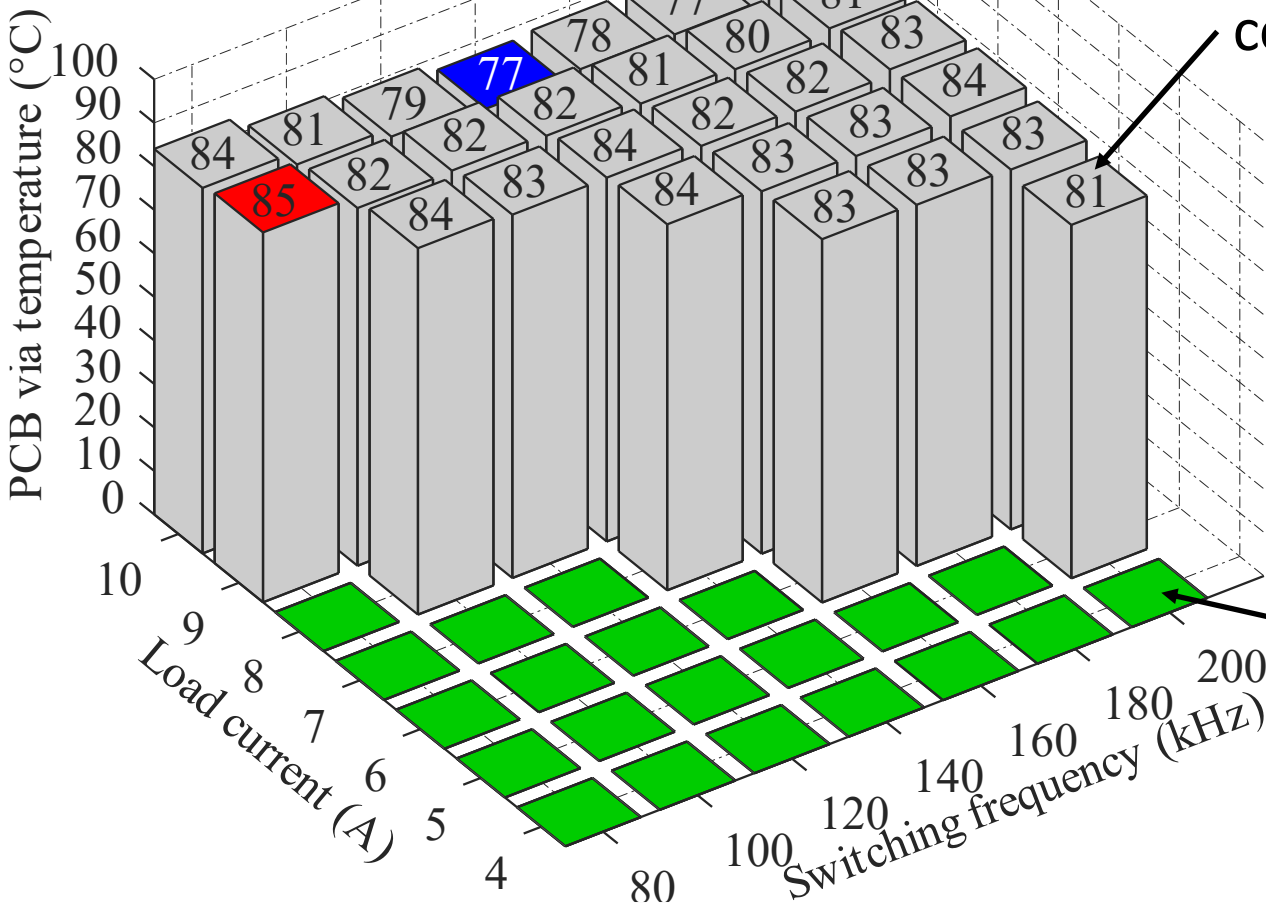
Turn-on di/dt measured at different junction temperatures



Over-temperature protection, experimental results

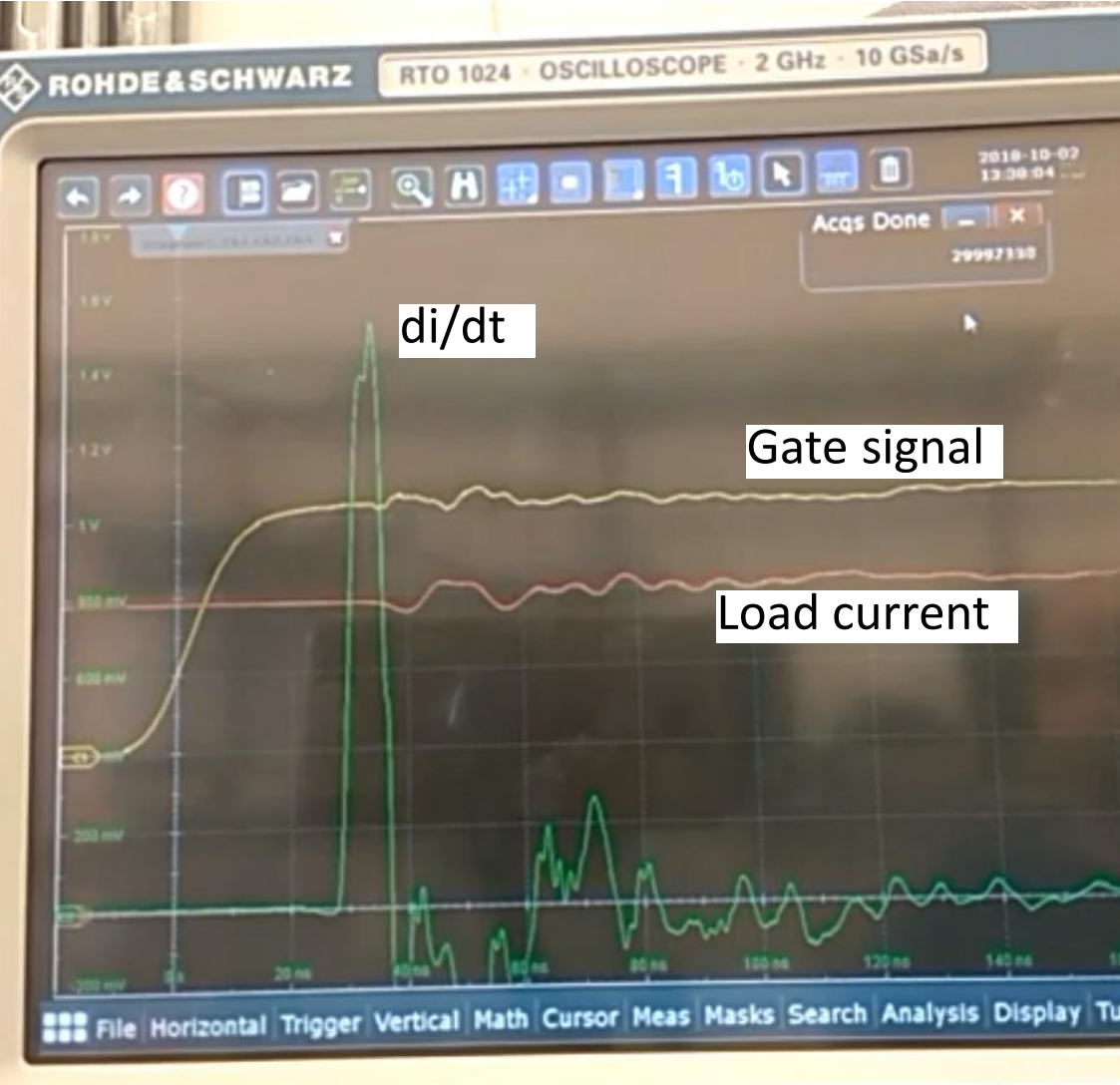
Junction temperature threshold set to 100°C

Circuit trips at this temperature, measured on via connected to case

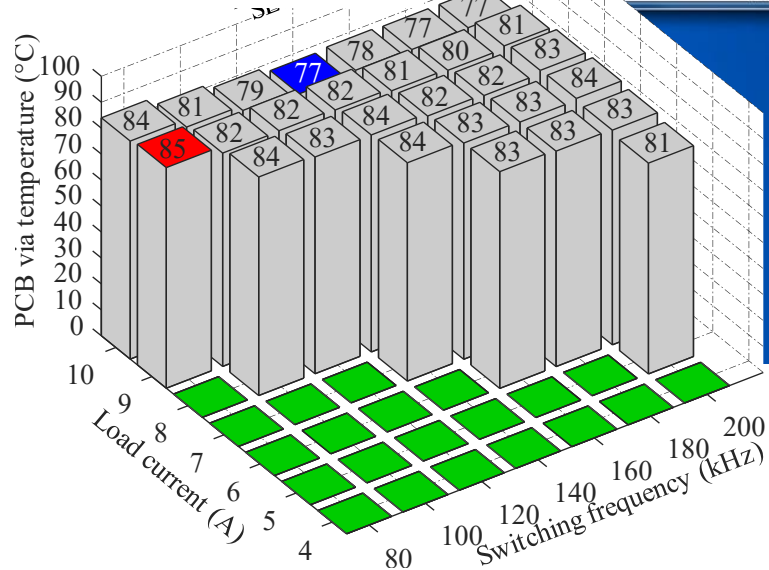


No trip

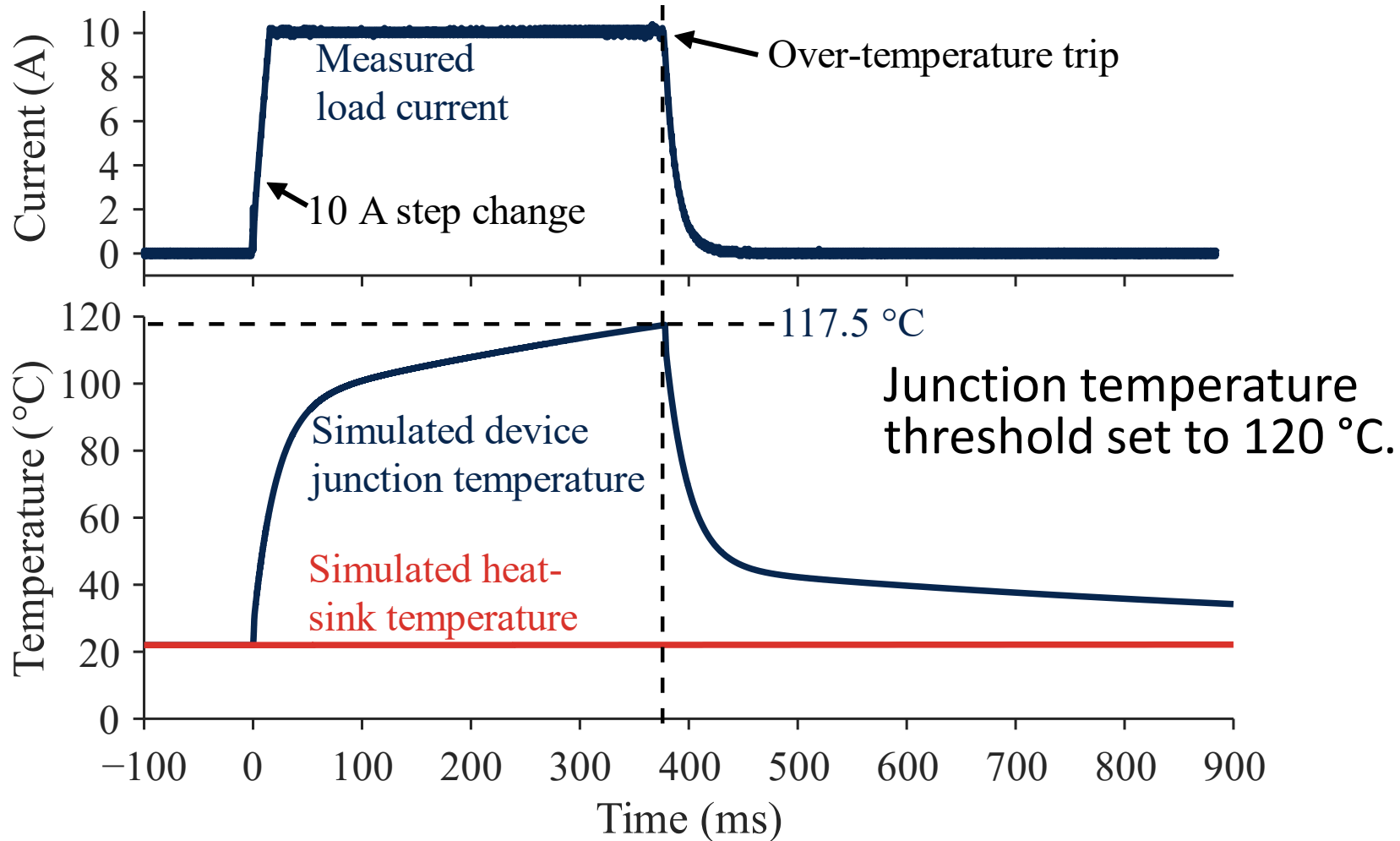
Demo



Junction temperature threshold set to 100°C



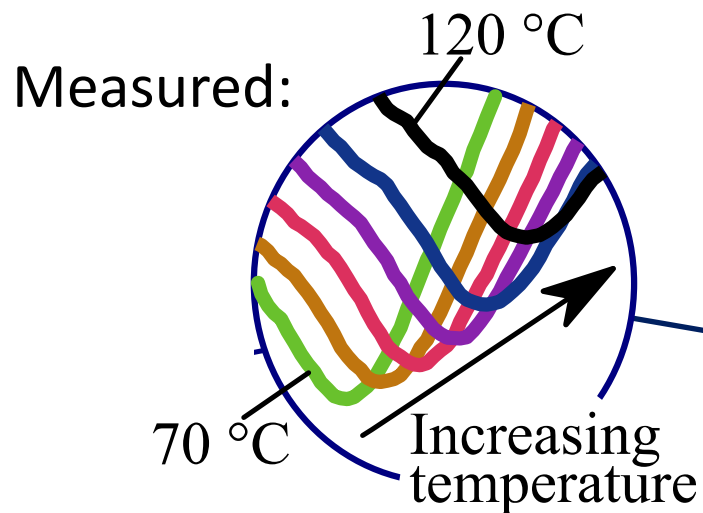
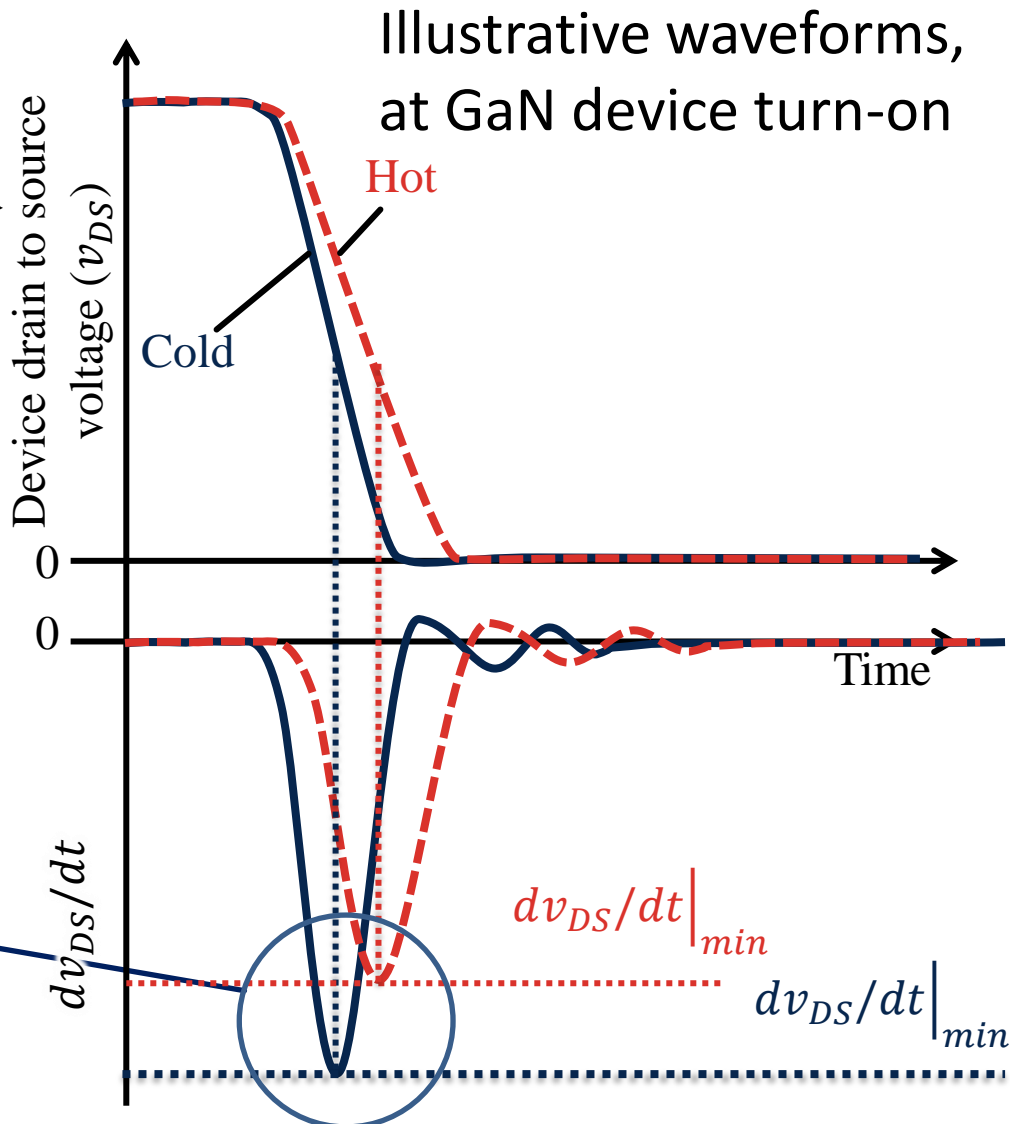
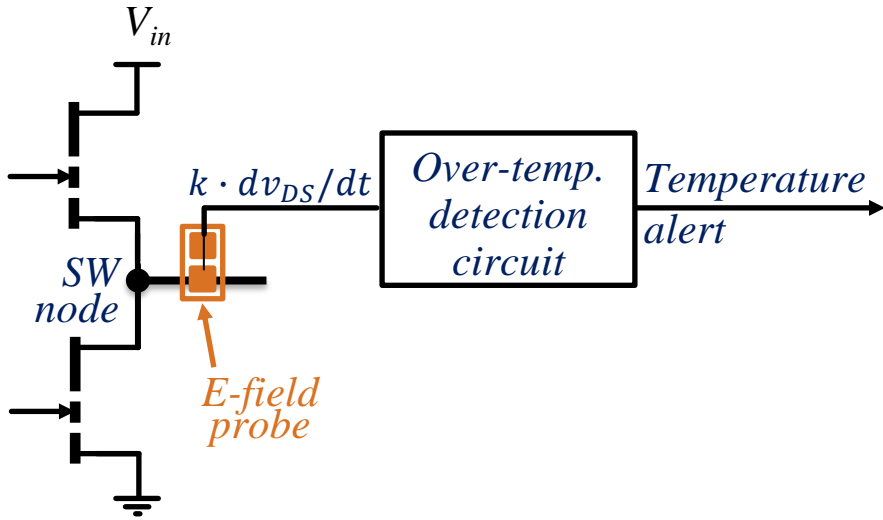
How fast does the protection circuit act?



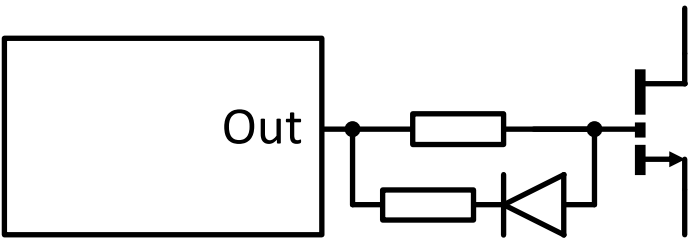
Demonstration of safe shutdown on highly overloaded GaN bridge-leg converter, operating at 10 A, 2 kW, and 500 kHz.

More info in **Over-Temperature Protection Circuit for GaN Devices Using a di/dt Sensor**, in IEEE Transactions on Power Electronics, 2021.

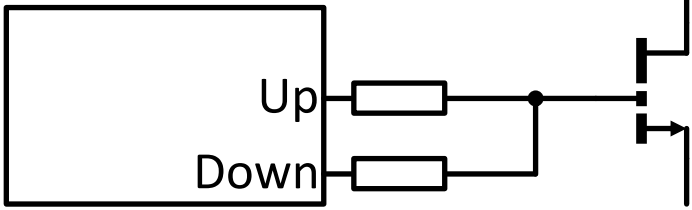
Voltage and temperature sensing using E-field (dV/dt)



Ongoing research in gate driving: Gate driver output options



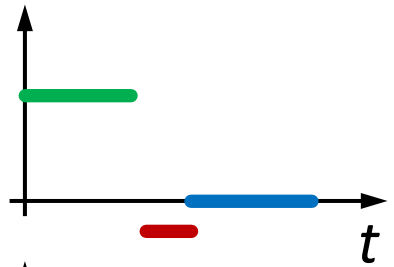
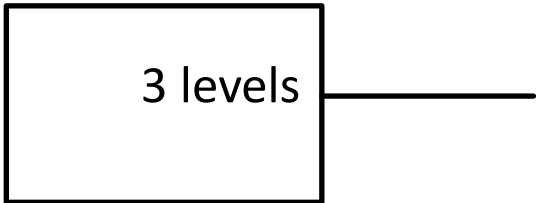
Problematic



Preferred

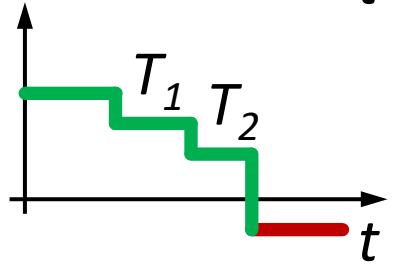
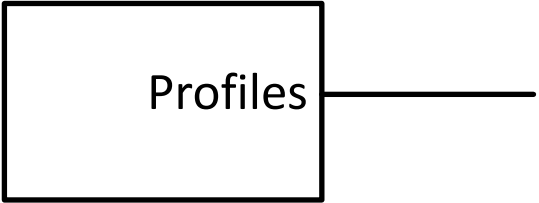
Manufacturer-recommended gate resistors

	GaN Systems	EPC
Off	0 – 2 Ω	0 Ω
On	10 – 20 Ω	2 Ω

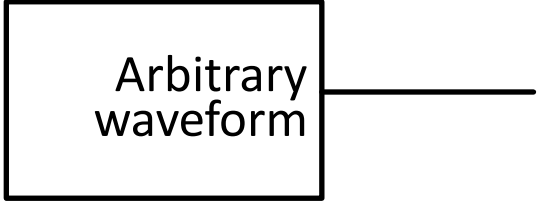


Available

Infineon EiceDRIVER 1edf5673k

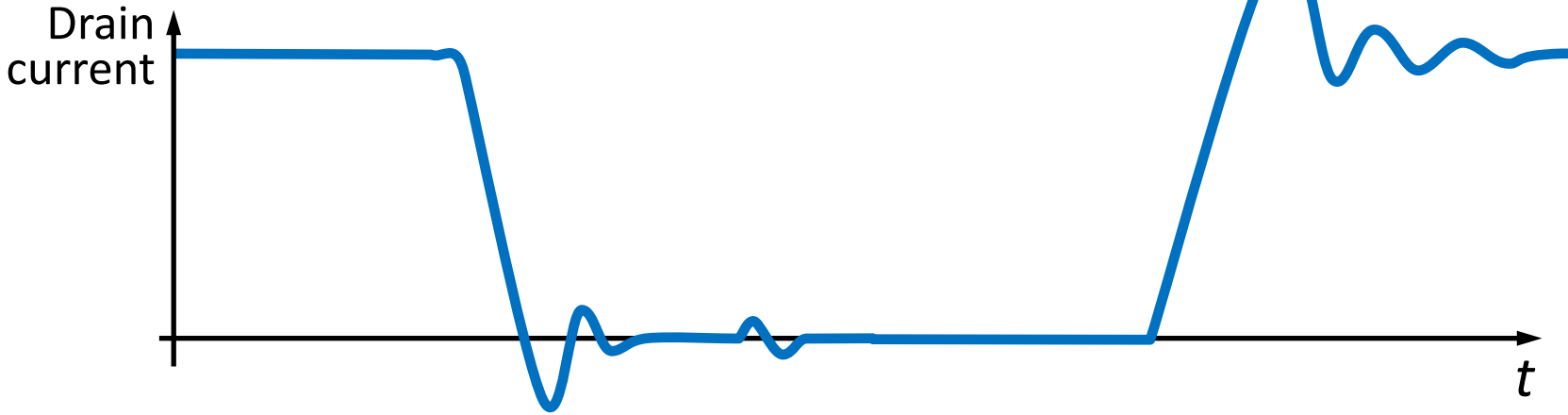


Becoming available

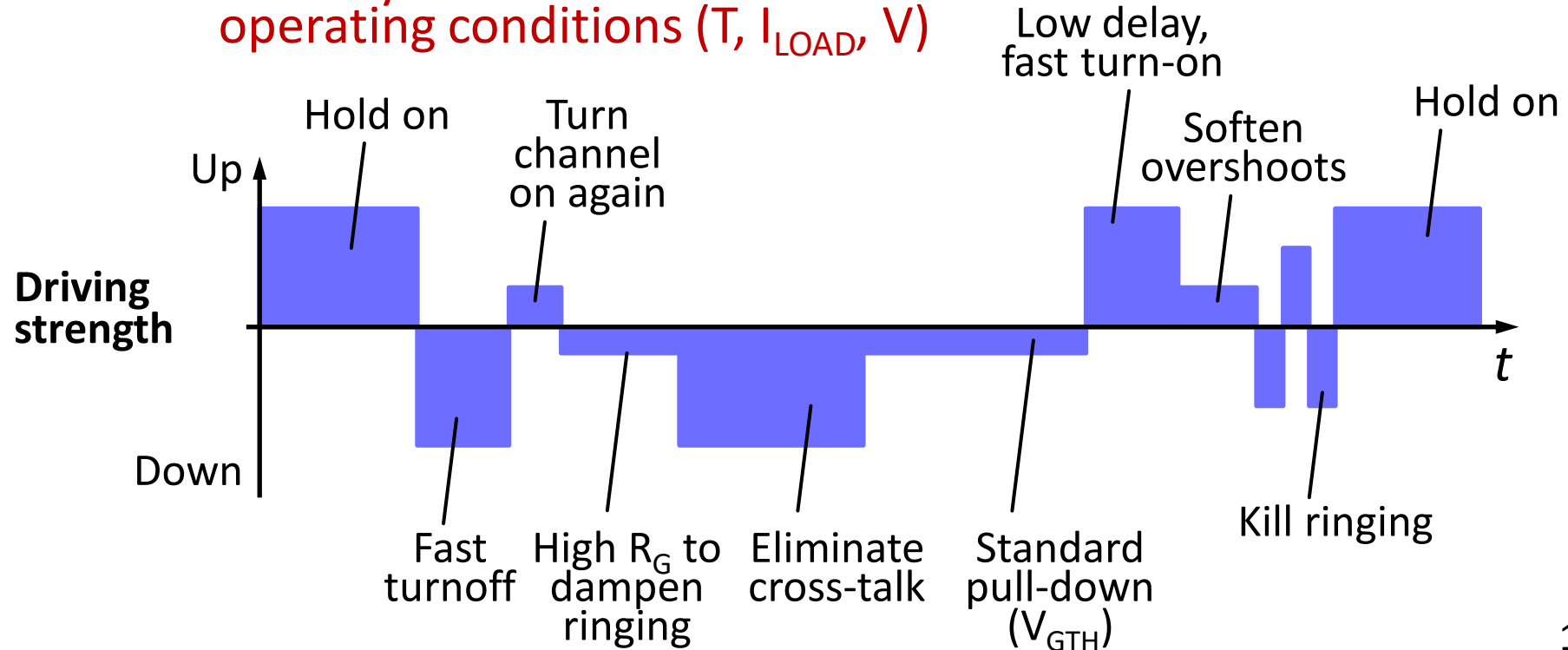


Research

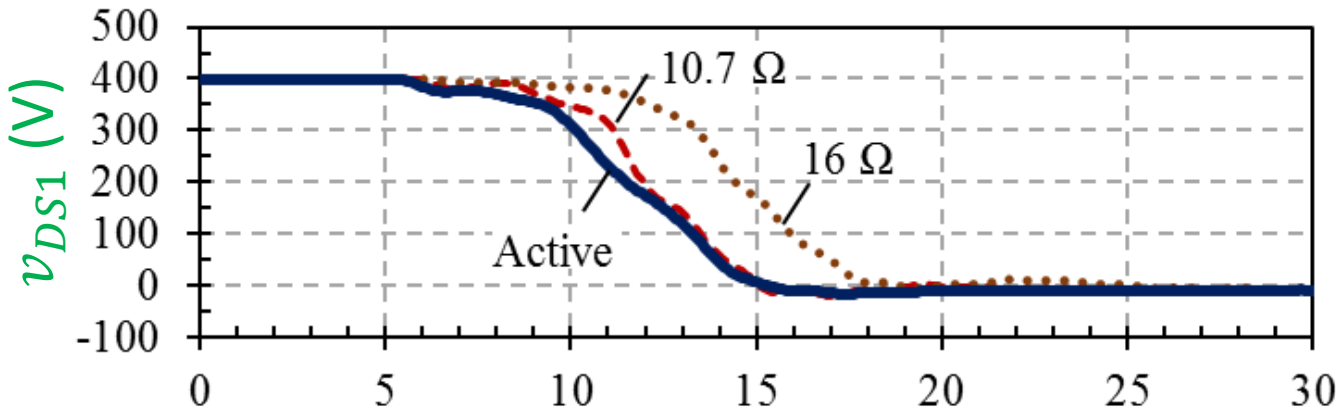
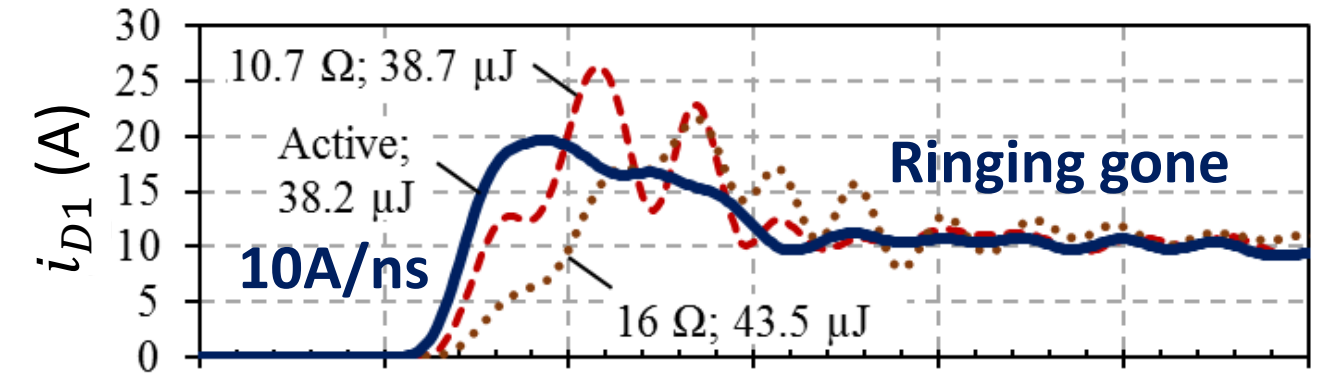
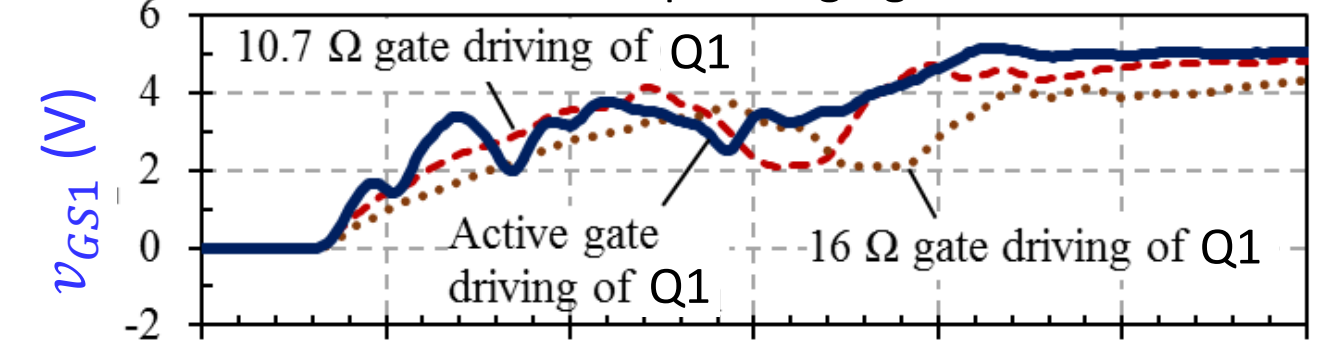
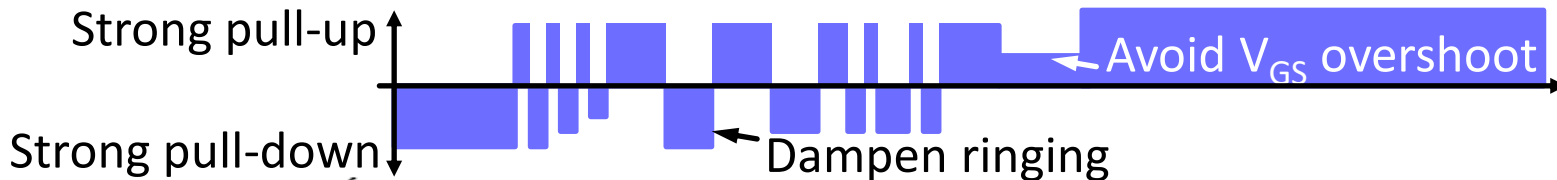
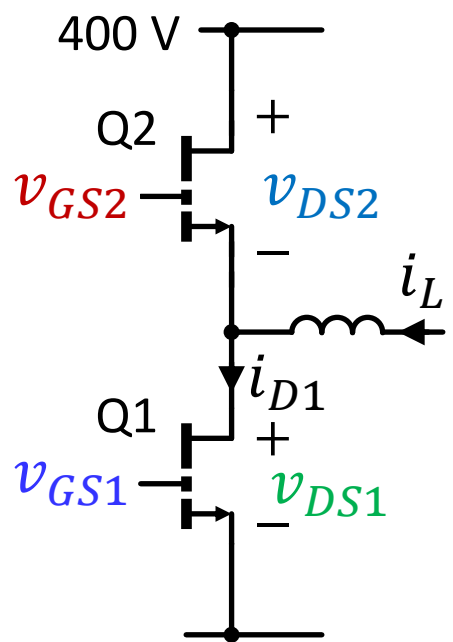
Why would you want a complex gate waveform?



Vary some of these with operating conditions (T , I_{LOAD} , V)



Speed up turn-on to 10A/ns to reduce loss, protect gate, and dampen current ringing

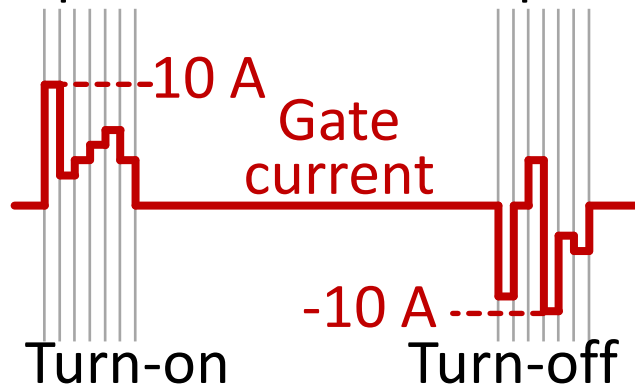


Arbitrary waveform driver

Approximate capability:

90 steps
100ps each

90 steps
100ps each



Steps every time light travels 3cm!

⇒ Useful tool for developing gate drivers.

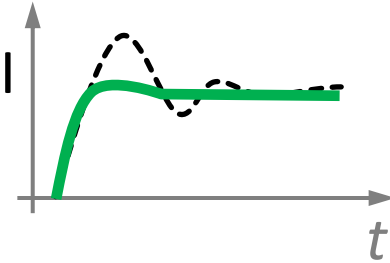
More info in

[Gen 3: Full custom design of an arbitrary waveform gate driver with 10 GHz waypoint rates for GaN FETs](#), in IEEE Transactions on Power Electronics, 2021

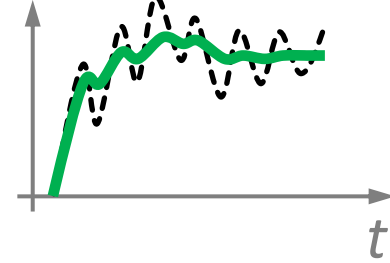
[Gen 2: A 6.7-GHz Active Gate Driver for GaN FETs to Combat Overshoot, Ringing, and EMI](#), IEEE Trans. Power Electronics, 2018.

Demonstrated on hard-switched GaN at **100 V/ns**

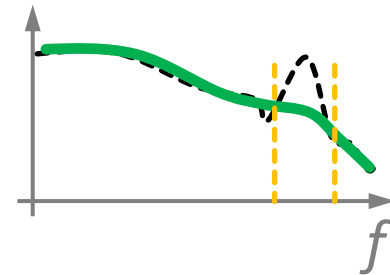
Reduce V & I overshoot



Reduce V & I ringing



Target a spectral EMI range



Online health tests?



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